# RUMENTS

#### 询**₩\$₩\$49℃**TH16245A-SP"供应商

#### FEATURES

- Members of the Texas Instruments Widebus™ Family
- State-of-the-Art Advanced BiCMOS Technology (ABT) Design for 3.3-V Operation and Low Static-Power Dissipation
- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V V<sub>CC</sub>)
- Support Unregulated Battery Operation Down to 2.7 V
- Typical V<sub>OLP</sub> (Output Ground Bounce) <0.8 V at  $V_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$
- Distributed V<sub>CC</sub> and GND Pins Minimize High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- Ioff and Power-Up 3-State Support Hot Insertion
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 500 mA Per **JESD 17**
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)

### SN54LVTH16245A, SN74LVTH16245A 3.3-V ABT 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS143R-MAY 1992-REVISED NOVEMBER 2006

SN54LVTH16			
SN74LVTH16245A.	DGG, (TOP VII		, OR DL PACKAGE
		_	
1DIR	$ _1 \cup$	48	1 <del>0E</del>
1B1	2	47	1A1
1B2	3		1A2
GND			GND GD
1B3	5		1A3
1B4	6	43	1A4
V <sub>cc</sub>	7	42	V <sub>CC</sub>
1B5	8		1A5
1B6			1A6
GND			GND
1B7			1A7
1B8			1A8
2B1			2A1
2B2	14		2A2
GND		34	GND
2B3			2A3
2B4			2A4
V <sub>CC</sub>		31	V <sub>CC</sub>
2B5			2A5
2B6			2A6
GND			GND
2B7			2A7
2B8			2A8
2DIR	24	25	2 <del>0E</del>

#### DESCRIPTION/ORDERING INFORMATION

The 'LVTH16245A devices are 16-bit (dual-octal) noninverting 3-state transceivers designed for low-voltage (3.3-V) V<sub>CC</sub> operation, but with the capability to provide a TTL interface to a 5-V system environment.

The devices are designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR) input and the output-enable (OE) input activate either the B-port outputs or the A-port outputs or place both output ports into the high-impedance mode. The device transmits data from the A bus to the B bus when the B-port outputs are activated, and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports is always active and must have a logic HIGH or LOW level applied to prevent excess I<sub>CC</sub> and I<sub>CCZ</sub>.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

When  $V_{CC}$  is between 0 and 1.5 V, the devices are in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V,  $\overline{OE}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

These devices are fully specified for hot-insertion applications using loff and power-up 3-state. The loff circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

**6**4

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Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet. Widebus is a trademark of Texas Instruments.

#### SN54LVTH16245A, SN74LVTH16245A 3.3-V ABT 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS scesims、MAX1992THEMISED(MOVEMBE(性)の) 商



T <sub>A</sub>	PACKAG	iE <sup>(1)</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	FBGA – GRD	Deal of 1000	SN74LVTH16245AGRDR	11.0454	
	FBGA – ZRD (Pb-free)	Reel of 1000	SN74LVTH16245AZRDR	— LL245A	
		Tube of 25	74LVTH16245ADL		
	SSOP – DL	Tube of 25	74LVTH16245ADLG4	LVTH16245A	
	330F - DL	Reel of 1000	74LVTH16245ADLR	LVINI0243A	
		Reel of 1000	74LVTH16245ADLRG4		
–40°C to 85°C			SN74LVTH16245ADGGR		
	TSSOP – DGG	Reel of 2000	74LVTH16245ADGGRE4	LVTH16245A	
			74LVTH16245ADGGRG4		
	TVSOP – DGV	Reel of 2000	SN74LVTH16245ADGVR	– LL245A	
	TVSOF - DGV	Reel 01 2000	74LVTH16245ADGVRE4	LL243A	
	VFBGA – GQL Reel of 1000		SN74LVTH16245AGQLR	– LL245A	
	VFBGA – ZQL (Pb-free)	Reel of 1000	74LVTH16245AZQLR	LLZ4JA	
–55°C to 125°C	CFP – WD	Tube	SNJ54LVTH16245AWD	SNJ54LVTH16245AWD	

#### ORDERING INFORMATION

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

#### **GQL OR ZQL PACKAGE** (TOP VIEW) 1 2 3 4 5 6 000000 Α 000000 в С 000000 D ()OOЕ F ()()G 0000000 0000000 Н 000000 J

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κ

#### TERMINAL ASSIGNMENTS<sup>(1)</sup> (56-Ball GQL/ZQL Package)

	1	2	3	4	5	6
Α	1DIR	NC	NC	NC	NC	1 <del>0E</del>
В	1B2	1B1	GND	GND	1A1	1A2
С	1B4	1B3	V <sub>CC</sub>	V <sub>CC</sub>	1A3	1A4
D	1B6	1B5	GND	GND	1A5	1A6
Е	1B8	1B7			1A7	1A8
F	2B1	2B2			2A2	2A1
G	2B3	2B4	GND	GND	2A4	2A3
н	2B5	2B6	V <sub>CC</sub>	V <sub>CC</sub>	2A6	2A5
J	2B7	2B8	GND	GND	2A8	2A7
κ	2DIR	NC	NC	NC	NC	2 <del>0E</del>

(1) NC – No internal connection

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1 2

Α

В

С

D

Е

F

G

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J

**GRD OR ZRD PACKAGE** 

(TOP VIEW)

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3 4 5 6

#### SN54LVTH16245A, SN74LVTH16245A 3.3-V ABT 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS SCB5143R-MAY 1992-REVISED NOVEMBER 2006

SCB

#### TERMINAL ASSIGNMENTS<sup>(1)</sup> (54-Ball GRD/ZRD Package)

	-					
	1	2	3	4	5	6
Α	1B1	NC	1DIR	1 <del>0E</del>	NC	1A1
В	1B3	1B2	NC	NC	1A2	1A3
С	1B5	1B4	V <sub>CC</sub>	V <sub>CC</sub>	1A4	1A5
D	1B7	1B6	GND	GND	1A6	1A7
Е	2B1	1B8	GND	GND	1A8	2A1
F	2B3	2B2	GND	GND	2A2	2A3
G	2B5	2B4	V <sub>CC</sub>	V <sub>CC</sub>	2A4	2A5
Н	2B7	2B6	NC	NC	2A6	2A7
J	2B8	NC	2DIR	2 <mark>0E</mark>	NC	2A8

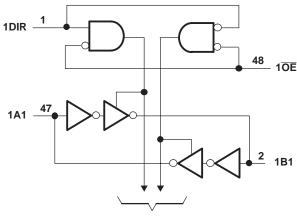
(1) NC - No internal connection

#### FUNCTION TABLE<sup>(1)</sup> (EACH 8-BIT SECTION)

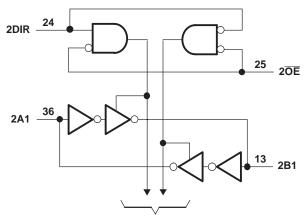
	TROL UTS	OUTPUT	CIRCUITS	OPERATION
ŌĒ	DIR A PORT		B PORT	
L	L	Enabled	Hi-Z	B data to A bus
L	н	Hi-Z	Enabled	A data to B bus
н	Х	Hi-Z	Hi-Z	Isolation

(1) Input circuits of the data I/Os always are active.

#### LOGIC DIAGRAM (POSITIVE LOGIC)



**To Seven Other Channels** 



**To Seven Other Channels** 

## SN54LVTH16245A, SN74LVTH16245A 3.3-V ABT 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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#### Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage range		-0.5	4.6	V
VI	Input voltage range <sup>(2)</sup>		-0.5	7	V
Vo	Voltage range applied to any output in the high-in	npedance or power-off state <sup>(2)</sup>	-0.5	7	V
Vo	Voltage range applied to any output in the high st	tate <sup>(2)</sup>	-0.5	$V_{CC} + 0.5$	V
	Comment into any output in the law state	SN54LVTH16245A		96	0
I <sub>O</sub>	Current into any output in the low state	SN74LVTH16245A		128	mA
	$\mathbf{O}$	SN54LVTH16245A		48	
I <sub>O</sub>	Current into any output in the high state <sup>(3)</sup>	SN74LVTH16245A		64	mA
I <sub>IK</sub>	Input clamp current	V <sub>1</sub> < 0		-50	mA
I <sub>OK</sub>	Output clamp current	V <sub>O</sub> < 0		-50	mA
		DGG package		70	
		DGV package		58	
$\theta_{JA}$	Package thermal impedance <sup>(4)</sup>	DL package		63	°C/W
		GQL/ZQL package		42	
		GRD/ZRD package		36	
T <sub>stg</sub>	Storage temperature range	·	-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) This current flows only when the output is in the high state and  $V_O > V_{CC}$ . (4) The package thermal impedance is calculated in accordance with JESD 51-7.

### **Recommended Operating Conditions**<sup>(1)</sup>

			SN54LVTH	16245A	SN74LVTH1	6245A	
			MIN	MAX	MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage		2.7	3.6	2.7	3.6	V
V <sub>IH</sub>	High-level input voltage		2		2		V
V <sub>IL</sub>	Low-level input voltage			0.8		0.8	V
VI	Input voltage			5.5		5.5	V
I <sub>OH</sub>	High-level output current			-24		-32	mA
I <sub>OL</sub>	Low-level output current			48		64	mA
$\Delta t / \Delta v$	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
$\Delta t / \Delta V_{CC}$	Power-up ramp rate		200		200		μs/V
T <sub>A</sub>	Operating free-air temperature		-55	125	-40	85	°C

(1) All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

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## SN54LVTH16245A, SN74LVTH16245A **3.3-V ABT 16-BIT BUS TRANSCEIVERS** WITH 3-STATE OUTPUTS

SCBS143R-MAY 1992-REVISED NOVEMBER 2006

#### **Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

	AMETER	TEOT OF		SN54L	VTH16245A		SN74L	/TH1624	5A	UNIT	
PAR	AWEIER	TEST CC	ONDITIONS	MIN	TYP <sup>(1)</sup>	MAX	MIN	TYP <sup>(1)</sup>	MAX	UNII	
V <sub>IK</sub>		V <sub>CC</sub> = 2.7 V,	I <sub>I</sub> = -18 mA			-1.2			-1.2	V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V},$	I <sub>OH</sub> = −100 μA	$V_{CC} - 0.2$			V <sub>CC</sub> - 0.2				
. ,		V <sub>CC</sub> = 2.7 V,	I <sub>OH</sub> = -8 mA	2.4			2.4				
V <sub>ОН</sub>			I <sub>OH</sub> = -24 mA	2						V	
		$V_{CC} = 3 V$	I <sub>OH</sub> = -32 mA				2				
		N/ 07N/	I <sub>OL</sub> = 100 μA			0.2			0.2		
		$V_{CC} = 2.7 V$	I <sub>OL</sub> = 24 mA			0.5			0.5		
.,			I <sub>OL</sub> = 16 mA			0.4			0.4	. /	
V <sub>OL</sub>			I <sub>OL</sub> = 32 mA			0.5			0.5	V	
		$V_{CC} = 3 V$	I <sub>OL</sub> = 48 mA			0.55					
			I <sub>OL</sub> = 64 mA						0.55		
	Control	V <sub>CC</sub> = 3.6 V,	$V_{I} = V_{CC}$ or GND			±1			±1		
	inputs	V <sub>CC</sub> = 0 or 3.6 V,	V <sub>I</sub> = 5.5 V			10			10		
l <sub>i</sub>			V <sub>I</sub> = 5.5 V			20			20	μA	
	A or B port <sup>(2)</sup>	V <sub>CC</sub> = 3.6 V	$V_{I} = V_{CC}$			5			5		
	pont		V <sub>1</sub> = 0			-5			-5		
I <sub>off</sub>	1	$V_{CC} = 0,$	$V_{I}$ or $V_{O}$ = 0 to 4.5 V						±100	μA	
		N/ 0.1/	V <sub>I</sub> = 0.8 V	75			75				
I	A or B	$V_{CC} = 3 V$	V <sub>I</sub> = 2 V	-75			-75			μA	
I(hold)	port	V <sub>CC</sub> = 3.6 V, <sup>(3)</sup>	V <sub>I</sub> = 0 to 3.6 V						500 -750	μΛ	
I <sub>OZPU</sub>		$\frac{V_{CC}}{OE} = 0$ to 1.5 V, V <sub>O</sub> = OE = don't care	0.5 V to 3 V,		±10	00 <sup>(4)</sup>			±100	μA	
I <sub>OZPD</sub>		$\frac{V_{CC}}{OE}$ = 1.5 V to 0, V <sub>O</sub> = OE = don't care	0.5 V to 3 V,		±10	00 <sup>(4)</sup>			±100	μA	
		V <sub>CC</sub> = 3.6 V,	Outputs high			0.19			0.19		
lcc	$I_{\Omega} = 0,$		Outputs low			5			5	mA	
	$V_1 = V_{CC}$ or GND		Outputs disabled			0.19			0.19		
$\Delta I_{CC}^{(5)}$		$V_{CC} = 3 V \text{ to } 3.6 V, \text{ Or}$ Other inputs at $V_{CC}$ or	ne input at V <sub>CC</sub> – 0.6 V, GND			0.2			0.2	mA	
C <sub>i</sub>		$V_1 = 3 V \text{ or } 0$			4			4		pF	
C <sub>io</sub>		$V_0 = 3 V \text{ or } 0$			10			10		pF	

 All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.
Unused pins at V<sub>CC</sub> or GND
This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

(4)

On products compliant to MIL-PRF-38535, this parameter is not production tested. This is the increase in supply current for each input that is at the specified TTL voltage level, rather than  $V_{CC}$  or GND. (5)

## SN54LVTH16245A, SN74LVTH16245A 3.3-V ABT 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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#### **Switching Characteristics**

over recommended operating free-air temperature range,  $C_L = 50 \text{ pF}$  (unless otherwise noted) (see Figure 1)

			SN5	64LVTH	16245	4		SN74L	VTH16	245A		
PARAMETER	FROM (INPUT)	TO (OUTPUT)			$V_{CC}$ = 2.7 V		V	cc = 3.3 ± 0.3 V	v	V <sub>CC</sub> =	2.7 V	UNIT
			MIN	MAX	MIN	MAX	MIN	TYP <sup>(1)</sup>	MAX	MIN	MAX	
t <sub>PLH</sub>	A or B	B or A	0.5	4.5		4.6	1.5	2.3	3.3		3.7	20
t <sub>PHL</sub>	AUB	BUIA	0.5	4.4		3.9	1.3	2.1	3.3		3.5	ns
t <sub>PZH</sub>	ŌĒ	A or B	0.5	6.5		6.6	1.5	2.8	4.5		5.3	ns
t <sub>PZL</sub>	OL	AUD	0.5	5.4		6.2	1.6	2.9	4.6		5.2	115
t <sub>PHZ</sub>	ŌĒ	A or B	1	6.8		7	2.3	3.7	5.1		5.5	20
t <sub>PLZ</sub>	UE	AUD	1	6.2		6.3	2.2	3.5	5.1		5.4	ns
t <sub>sk(LH)</sub>									0.5		0.5	20
t <sub>sk(HL)</sub>									0.5		0.5	ns

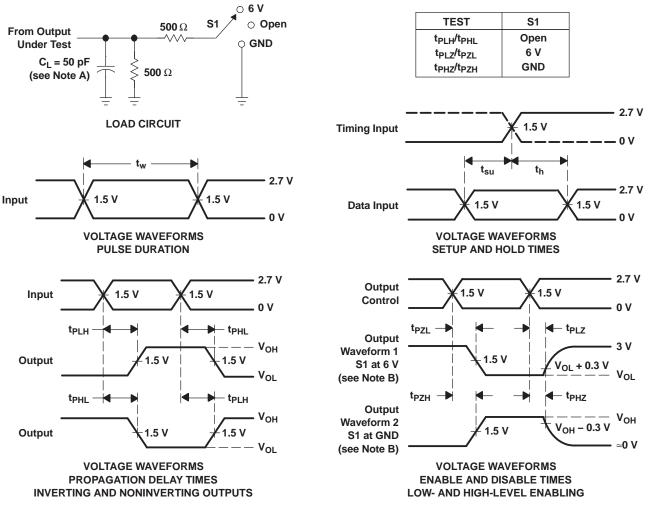
(1) All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

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## SN54LVTH16245A, SN74LVTH16245A 3.3-V ABT 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>1</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>r</sub>  $\leq$  2.5 ns, t<sub>f</sub>  $\leq$  2.5 ns.
- D. The outputs are measured one at a time, with one transition per measurement.

#### Figure 1. Load Circuit and Voltage Waveforms

15-Oct-2009

#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
5962-9668601QXA	ACTIVE	CFP	WD	48	1	TBD	A42	N / A for Pkg Type
5962-9668601VXA	ACTIVE	CFP	WD	48	1	TBD	A42	N / A for Pkg Type
74LVTH16245ADGGRE4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74LVTH16245ADGGRG4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74LVTH16245ADGVRE4	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74LVTH16245ADGVRG4	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74LVTH16245ADLG4	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74LVTH16245ADLRG4	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVTH16245ADGGR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVTH16245ADGVR	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVTH16245ADL	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVTH16245ADLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVTH16245AGQLR	NRND	BGA MI CROSTA R JUNI OR	GQL	56	1000	TBD	SNPB	Level-1-240C-UNLIM
SN74LVTH16245AGRDR	ACTIVE	BGA MI CROSTA R JUNI OR	GRD	54	1000	TBD	SNPB	Level-1-240C-UNLIM
SN74LVTH16245AZQLR	ACTIVE	BGA MI CROSTA R JUNI OR	ZQL	56	1000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM
SN74LVTH16245AZRDR	ACTIVE	BGA MI CROSTA R JUNI OR	ZRD	54	1000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM
SNJ54LVTH16245AWD	ACTIVE	CFP	WD	48	1	TBD	A42	N / A for Pkg Type

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements

## PACKAGE OPTION ADDENDUM

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for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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#### OTHER QUALIFIED VERSIONS OF SN54LVTH16245A, SN54LVTH16245A-SP, SN74LVTH16245A :

Automotive: SN74LVTH16245A-Q1

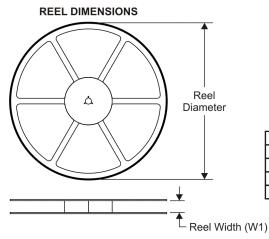
Enhanced Product: SN74LVTH16245A-EP

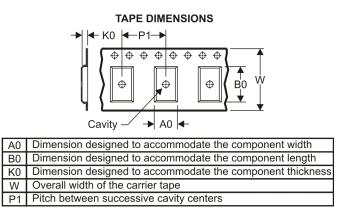
NOTE: Qualified Version Definitions:

- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product Supports Defense, Aerospace and Medical Applications

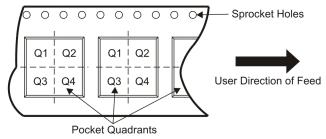
₩ Texas INSTRUMENTS 查询"SN54LVTH16245A-SP"供应商

#### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

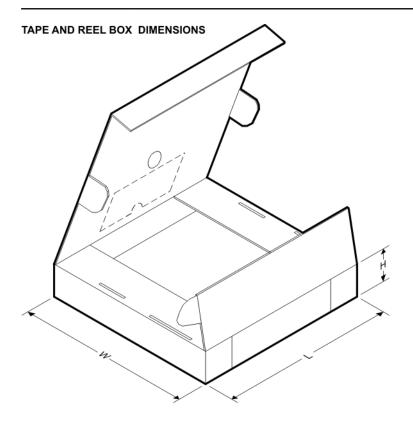


Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LVTH16245ADGGR	TSSOP	DGG	48	2000	330.0	24.4	8.6	15.8	1.8	12.0	24.0	Q1
SN74LVTH16245ADGVR	TVSOP	DGV	48	2000	330.0	16.4	7.1	10.2	1.6	12.0	16.0	Q1
SN74LVTH16245ADLR	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1
SN74LVTH16245AGQLR	BGA MI CROSTA R JUNI OR	GQL	56	1000	330.0	16.4	4.8	7.3	1.45	8.0	16.0	Q1
SN74LVTH16245AGRDR	BGA MI CROSTA R JUNI OR	GRD	54	1000	330.0	16.4	5.8	8.3	1.55	8.0	16.0	Q1
SN74LVTH16245AZQLR	BGA MI CROSTA R JUNI OR	ZQL	56	1000	330.0	16.4	4.8	7.3	1.45	8.0	16.0	Q1
SN74LVTH16245AZRDR	BGA MI CROSTA R JUNI OR	ZRD	54	1000	330.0	16.4	5.8	8.3	1.55	8.0	16.0	Q1



## PACKAGE MATERIALS INFORMATION

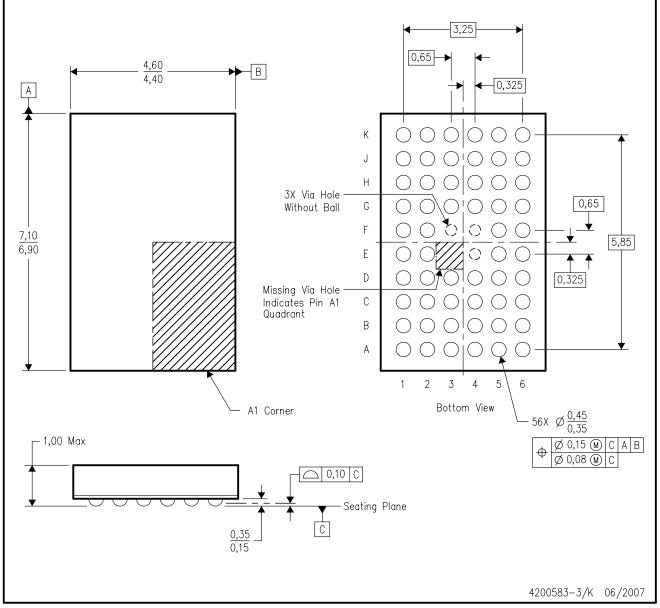
11-Aug-2009



All dimensions are nominal							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LVTH16245ADGGR	TSSOP	DGG	48	2000	346.0	346.0	41.0
SN74LVTH16245ADGVR	TVSOP	DGV	48	2000	346.0	346.0	33.0
SN74LVTH16245ADLR	SSOP	DL	48	1000	346.0	346.0	49.0
SN74LVTH16245AGQLR	BGA MICROSTAR JUNIOR	GQL	56	1000	346.0	346.0	33.0
SN74LVTH16245AGRDR	BGA MICROSTAR JUNIOR	GRD	54	1000	346.0	346.0	33.0
SN74LVTH16245AZQLR	BGA MICROSTAR JUNIOR	ZQL	56	1000	346.0	346.0	33.0
SN74LVTH16245AZRDR	BGA MICROSTAR JUNIOR	ZRD	54	1000	346.0	346.0	33.0

## GQL (R-PBGA-N56)

## PLASTIC BALL GRID ARRAY



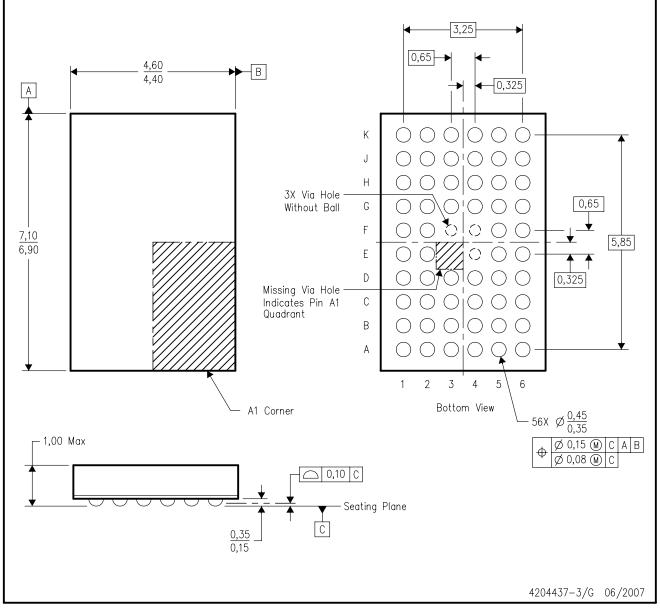
NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-285 variation BA-2.
- D. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.



## ZQL (R-PBGA-N56)

## PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-285 variation BA-2.
- D. This package is lead-free. Refer to the 56 GQL package (drawing 4200583) for tin-lead (SnPb).

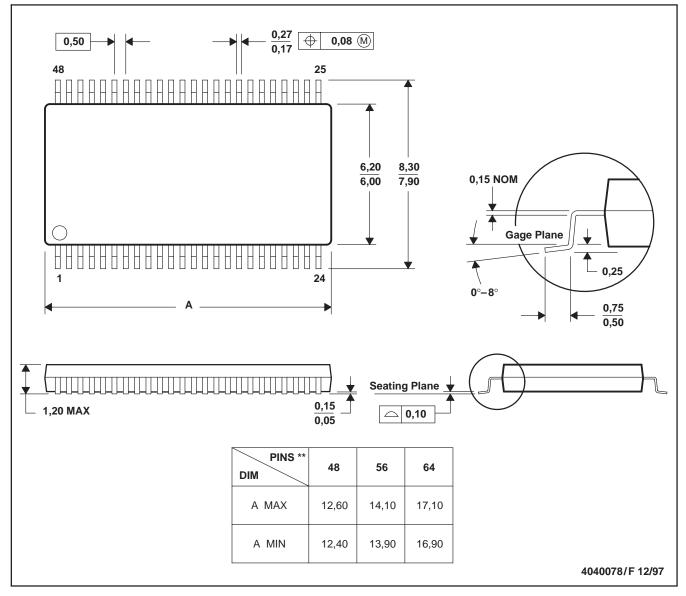


#### <u> 查询"SN54LVTH16245A-SP"供应商</u>

MTSS003D – JANUARY 1995 – REVISED JANUARY 1998 PLASTIC SMALL-OUTLINE PACKAGE

#### DGG (R-PDSO-G\*\*)

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



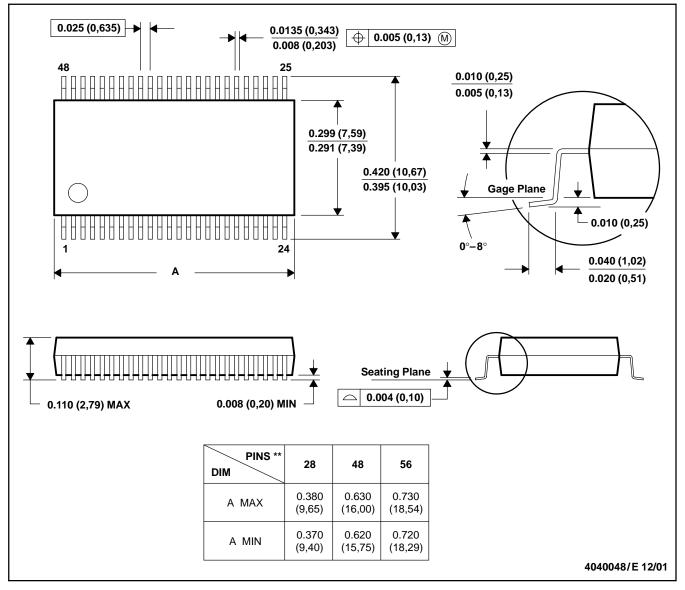
#### <u> 查询"SN54LVTH16245A-SP"供应商</u>

MSSO001C - JANUARY 1995 - REVISED DECEMBER 2001

PLASTIC SMALL-OUTLINE PACKAGE

#### DL (R-PDSO-G\*\*)

**48 PINS SHOWN** 



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118



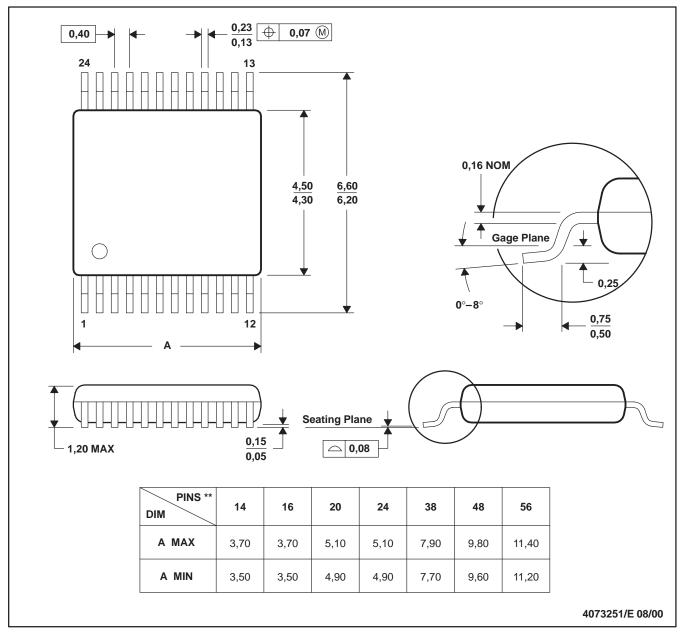
#### <u> 查询"SN54LVTH16245A-SP"供应商</u>

MPDS006C – FEBRUARY 1996 – REVISED AUGUST 2000

PLASTIC SMALL-OUTLINE

#### DGV (R-PDSO-G\*\*)

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

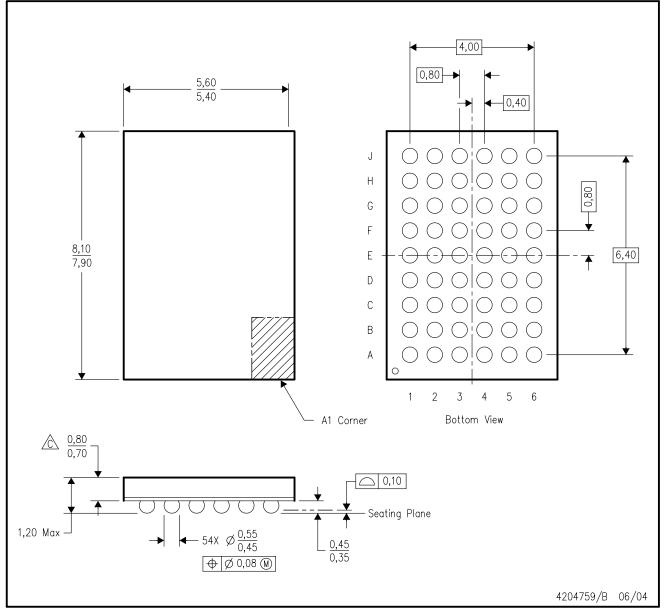
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153

14/16/20/56 Pins – MO-194



GRD (R-PBGA-N54)

PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

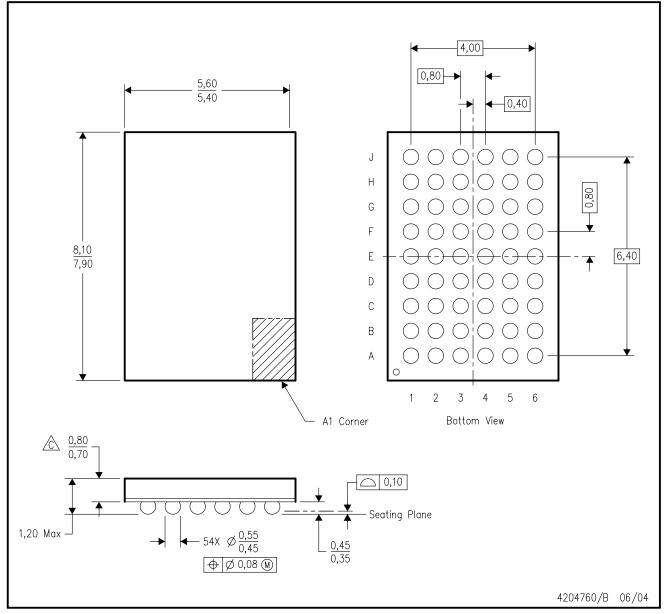
Falls within JEDEC MO-205 variation DD.

D. This package is tin-lead (SnPb). Refer to the 54 ZRD package (drawing 4204760) for lead-free.



## ZRD (R-PBGA-N54)

PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

Falls within JEDEC MO-205 variation DD.

D. This package is lead-free. Refer to the 54 GRD package (drawing 4204759) for tin-lead (SnPb).

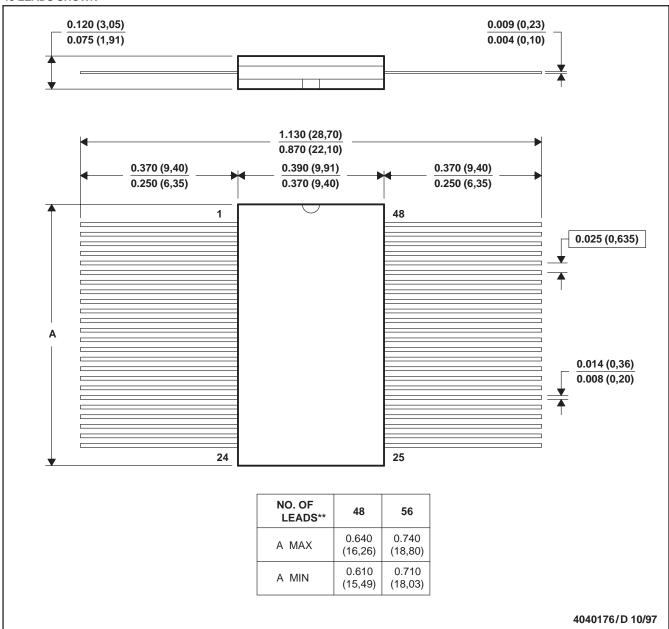


MCFP010B - JANUARY 1995 - REVISED NOVEMBER 1997

#### <u> 查询"SN54LVTH16245A-SP"供应商</u>

#### **CERAMIC DUAL FLATPACK**

WD (R-GDFP-F\*\*) 48 LEADS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only
  - E. Falls within MIL STD 1835: GDFP1-F48 and JEDEC MO-146AA
    - GDFP1-F56 and JEDEC MO-146AB



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